

08-19-2004

8. 9. 04

FORM PTO-1595
(Rev. 10/02)
OMD No. 0651-0011 (exp. 6/30/2005)



102817936

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

John Barnak; Collin Borla; Mark Doczy; Markus Kuhn;
Jacob M. Jensen

2. Name and address of receiving party(ies):

Name: **Intel Corporation**

Internal Address:

Street Address: **2200 Mission College Boulevard**

City: **Santa Clara** State: **CA** Zip: **95052**

Country: **USA**

Additional name(s) of conveying party(ies) attached?

☒ No ☐ Yes

3. Nature of Conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: **1/20/2003; 1/21/2003; 3/04/2003**

Additional name(s) & address(es) attached? ☒ No ☐ Yes

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

8-09-2004

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☒ No ☐ Yes

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Blakely, Sokoloff, Taylor & Zafman LLP**

Internal Address:

Street Address: **12400 Wilshire Boulevard**
7th Floor

City: **Los Angeles** State: **CA** ZIP: **90025**

6. Total number of applications and patents involved: **1**

7. Total Fee (37 CFR 3.41).....\$ **40.00**

☒ Enclosed
☐ Authorized to be charged to deposit account

8. Deposit Account Number:

02-2666

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

08/18/2004 DBYRHE 00000055 10916191

01 FC:002

40.00 OP

Paul A. Mendonsa

Name of Person Signing

Paul A. Mendonsa

Signature

August 9, 2004

Date

Total number of pages including cover sheet, attachments, and document:

Mail documents to be recorded with required cover sheet information to:

Mail Stop Assignment Recordation Services
Director of the US Patent and Trademark Office
P.O. Box 1450
Alexandria, VA 22313-1450

Docket No. 42P15041D

PATENT
REEL: 015684 FRAME: 0153

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned:

John Barnak; Collin Borla; Mark Doczy; Markus Kuhn; Jacob M. Jensen

hereby sell, assign, and transfer to:

Intel Corporation

a Corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California 95052-8119 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all inventions and improvements that are disclosed in the application for the United States patent filed on December 9, 2002, and assigned Application No. 10/315,646 and is entitled:

METHODS OF FORMING A MULTILAYER STACK ALLOY FOR WORK FUNCTION ENGINEERING

and in and to said application and all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications that have been or shall be filed in the United States and all foreign countries on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all foreign countries on said inventions and improvements; and in and to all rights of priority resulting from the filing of said United States application;

agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Each Inventor: Please Sign and Date Below:

Date

Name: **John Barnak**

Date

Name: **Collin Borla**

Date

Name: **Mark Doczy**

Date

Name: **Markus Kuhn**

Date

Name: **Jacob M. Jensen**

Date

Name:

Date

Name:

Date

Name:

Date

Name:

Date

Name:

Date

Name:

Assignment Document Return Address:

BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP
12400 Wilshire Blvd., Seventh Floor
Los Angeles, CA 90025-1026
Telephone: (503) 684-6200

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Each Inventor: Please Sign and Date Below:

Date

Name: **John Barnak**

1/21/03

Collin Borla

Date

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Date

Name: **Mark Doczy**

Date

Name: **Markus Kuhn**

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Each Inventor: Please Sign and Date Below:

Date _____ Name: **John Barnak**

Date _____ Name: **Collin Borla**

Date _____ Name: **Mark Doczy**

Date _____ Name: **Markus Kuhn**

21 JAN 2003
Date _____ Name: **Jacob M. Jensen**

Date _____ Name: _____

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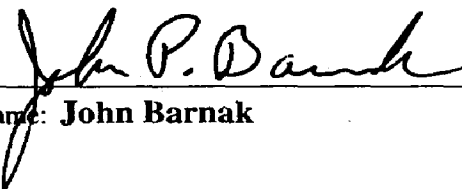
agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

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Each Inventor: Please Sign and Date Below:

3/04/03

Date



Name: **John Barnak**

Date

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3/4/03	<i>Mark Doczy</i>
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